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ULTRA PRECISION DUAL 2:1 400mV LVPECL MUX WITH INTERNAL TERMINATION

Precision Edge<sup>®</sup> SY58027U

#### **FEATURES**

- Two independent differential 2:1 multiplexers
- Guaranteed AC performance over temperature and voltage:
  - DC-to >10.7Gbps data rate throughput
  - < 290ps IN-to-Out t<sub>pd</sub>
  - < 80ps t<sub>r</sub> / t<sub>f</sub>
- Unique, patent-pending input isolation design minimizes crosstalk
- Ultra-low jitter design:
  - <1ps<sub>RMS</sub> random jitter
  - <10ps<sub>pp</sub> deterministic jitter
  - <10ps<sub>pp</sub> total jitter (clock)
  - <0.7ps<sub>RMS</sub> crosstalk-induced jitter
- Unique, patent-pending 50ý input termination and VT pin accepts DC-coupled and AC-coupled inputs (CML, LVDS, PECL)
- 400mV LVPECL output swing
- Power supply 2.5V ±5% or 3.3V ±10%
- -40°C to +85°C temperature range
- Available in 32-pin (5mm ∞ 5mm) MLF® package

#### **APPLICATIONS**

- Data communication systems
- All SONET OC3-OC768 applications
- All Fibre Channel applications
- All GigE applications

Precision Edge<sup>®</sup>

#### **DESCRIPTION**

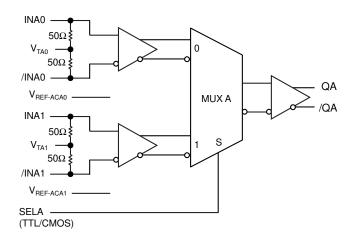
The SY58027U features two ultra-fast, low jitter 2:1 differential muxes with a guaranteed maximum data throughput of 10.7Gbps.

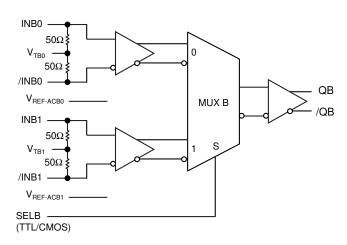
The SY58027U differential inputs include a unique internal termination design that allows access to the termination network through a VT pin. The device easily interfaces to different logic standards, both AC- and DC-coupled, without external resistor-bias and termination networks. The result is a clean, stub-free, low jitter interface solution. The differential 400mV LVPECL outputs have extremely fast rise/fall times guaranteed to be less than 80ps.

The SY58027U operates from a 2.5V or 3.3V supply and is guaranteed over the full industrial temperature range ( $-40^{\circ}$ C to +85°C). The SY58027U is part of Micrel's Precision Edge<sup>®</sup> product family.

All support documentation can be found on Micrel's web site at www.micrel.com.

#### FUNCTIONAL BLOCK DIAGRAM

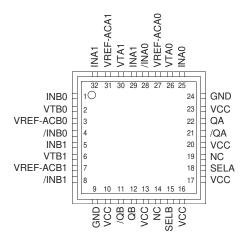




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Rev.: D Amendment: /0 Issue Date: August 2007

### PACKAGE/ORDERING INFORMATION



32-Pin MLF® (MLF-32)

## Ordering Information<sup>(1)</sup>

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY58027UMI	MLF-32	Industrial	SY58027U	Sn-Pb
SY58027UMITR <sup>(2)</sup>	MLF-32	Industrial	SY58027U	Sn-Pb
SY58027UMG <sup>(3)</sup>	MLF-32	Industrial	SY58027U with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY58027UMGTR <sup>(2, 3)</sup>	MLF-32	Industrial	SY58027U with Pb-Free bar-line indicator	Pb-Free NiPdAu

#### Notes

- 1. Contact factory for die availability. Dice are guaranteed at  $T_A$  = 25°C, DC electricals only.
- 2. Tape and Reel.
- 3. Pb-Free package recommended for new designs.

### PIN DESCRIPTION

Pin Number	Pin Name	Pin Function
25, 28, 29, 32, 1, 4, 5, 8	INA0, /INA0, INA1, /INA1, INB0, /INB0, INB1, /INB1	Differential Inputs: These input pairs are the differential signal inputs to the device. Inputs accept AC- or DC-coupled differential signals as small as 100mV. Each pin of a pair internally terminates to a VT pin through 50ý. Note that these inputs will default to an indeterminate state if left open. Unused differential input pairs can be terminated by connecting one input to $V_{CC}$ and the complementary input to GND through a 1ký resistor. The VT pin is to be left open in this configuration. Please refer to the "Input Interface Applications" section for more details.
26, 30, 2, 6	VTA0 , VTA1, VTB0, VTB1	Input Termination Center-Tap: Each side of the differential input pair, terminates to a VT pin. Each VT pin provides a center-tap to a termination network for maximum interface flexibility. See "Input Interface Applications" section for more details.
18, 15	SELA, SELB	Bank A, Bank B Input Channel Select (TTL/CMOS): These TTL/CMOS-compatible inputs select the inputs to the multiplexers. These inputs are internally connected to a 25ký pull-up resistor and will default to a logic HIGH state if left open. Input switching threshold is $V_{\rm CC}/2$ .
27, 31, 3, 7	VREF-ACA0, VREF-ACA1, VREF-ACB0, VREF-ACB1	Reference Output Voltage: These outputs bias to $V_{CC}$ –1.2V. Connect to VT pin when AC-coupling the data inputs. Bypass with 0.01 $\mu$ F low ESR capacitor to $V_{CC}$ . Maximum current source or sink is 0.5mA. See "Input Interface Applications" section.
10, 13, 16, 17, 20, 23	VCC	Positive Power Supply: Bypass with 0.1μF™30.01μF low ESR capacitors.
22, 21, 12, 11	QA, /QA, QB, /QB	Differential 100k LVPECL Outputs: MUX A and MUX B selected LVPECL outputs.  See "Output Interface Applications" section for termination. Refer to the "Truth Table" for logic operation.
9, 24	GND, Exposed pad	Ground: Ground pins and exposed pad must be connected to the same ground plane.
14, 19	NC	Not connected.

## **Absolute Maximum Ratings**(1)

–0.5V to +4.0V –0.5V to V <sub>CC</sub>
50mA
100mA
±100mA
±50mA
±1.5mA
260°C –65°C to +150°C

## Operating Ratings<sup>(2)</sup>

#### DC ELECTRICAL CHARACTERISTICS<sup>(5)</sup>

 $T_A = -40$ °C to +85°C; Unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
$V_{CC}$	Power Supply	V <sub>CC</sub> = 2.5V V <sub>CC</sub> = 3.3V	2.375 3.0	2.5 3.3	2.625 3.6	V
I <sub>CC</sub>	Power Supply Current	No load, max. V <sub>CC</sub> .		100	140	mA
R <sub>DIFF_IN</sub>	Differential Input Resistance (IN-to-/IN)		80	100	120	ý
R <sub>IN</sub>	Input Resistance (IN-to-V <sub>T</sub> , /IN-to-V <sub>T</sub> )		40	50	60	ý
$V_{IH}$	Input High Voltage (IN, /IN)	Note 6	V <sub>CC</sub> -1.6		V <sub>CC</sub>	V
V <sub>IL</sub>	Input Low Voltage (IN, /IN)		0		V <sub>IH</sub> -0.1	V
V <sub>IN</sub>	Input Voltage Swing (IN, /IN)	See Figure 1a.	0.1		1.7	V
V <sub>DIFF_IN</sub>	Differential Input Voltage Swing   IN – /IN	See Figure 1b.	0.2			V
V <sub>T IN</sub>	In to V <sub>T</sub> (IN, /IN)				1.28	V
V <sub>REF-AC</sub>	Output Reference Voltage		V <sub>CC</sub> -1.3	V <sub>CC</sub> -1.2	V <sub>CC</sub> -1.1	V

#### Notes:

- 1. Permanent device damage may occur if ratings in the "Absolute Maximum Ratings" section are exceeded. This is a stress rating only and functional operation is not implied for conditions other than those detailed in the operational sections of this data sheet. Exposure to absolute maximum ratings conditions for extended periods may affect device reliability.
- 2. The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- 3. Due to the limited drive capability, use for input of the same package only.
- 4. Junction-to-board resistance assumes exposed pad is soldered (or equivalent) to the device's most negative potential (GND) on the PCB.  $\Psi_{JB}$  uses 4-layer  $\theta_{JA}$  in still air unless otherwise stated.
- 5. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.
- 6. VIH (min) not lower than 1.2V.

## LVPECL OUTPUTS DC ELECTRICAL CHARACTERISTICS(6)

 $V_{CC}$  = 2.5V ±5% or 3.3V ±10%;  $T_A$  = -40°C to +85°C;  $R_L$  = 50ý to  $V_{CC}$ -2V, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
V <sub>OH</sub>	Output HIGH Voltage Q, /Q		V <sub>CC</sub> -1.145	_	V <sub>CC</sub> -0.895	V
$V_{OL}$	Output LOW Voltage Q, /Q		V <sub>CC</sub> -1.545	_	V <sub>CC</sub> -1.295	V
V <sub>OUT</sub>	Output Voltage Swing Q, /Q	See Figure 1a.	150	400		mV
V <sub>DIFF-OUT</sub>	Differential Output Voltage Swing  Q-/Q	See Figure 1b.	300	800		mV

## LVTTL/CMOS DC ELECTRICAL CHARACTERISTICS(6)

 $V_{CC}$  = 2.5V ±5% or 3.3V ±10%;  $T_A$ = -40°C to 85°C unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
$V_{IH}$	Input HIGH Voltage		2.0			V
$V_{IL}$	Input LOW Voltage				0.8	V
I <sub>IH</sub>	Input HIGH Current		-175		75	μΑ
I <sub>IL</sub>	Input LOW Current	$V_{IL} = 0V$	-300			μΑ

#### Note:

6. The circuit is designed to meet the DC specifications shown in the above table after thermal equilibrium has been established.

#### AC ELECTRICAL CHARACTERISTICS(7)

 $V_{CC}$  = 2.5V ±5% or 3.3V ±10%;  $T_A$ = -40°C to +85°C;  $R_L$  = 50ý to  $V_{CC}$ -2V, unless otherwise stated.

Symbol	Parameter	Condition	Min	Тур	Max	Units
f <sub>MAX</sub>	Maximum Operating Frequency	V <sub>OUT</sub> ž 200mV NRZ Data	10.7	7		Gbps GHz
t <sub>pd</sub>	Propagation Delay IN-to-Q	V <sub>IN</sub> ž 300mV	140	215	290	ps
	SEL-to-Q		100	220	400	ps
t <sub>SKEW</sub>	Input-to-Input Skew (Within-bank)	Note 8		6	15	ps
	Bank-to-Bank Skew	Note 9		8	20	ps
	Part-to-Part Skew	Note 10			100	ps
t <sub>JITTER</sub>	Data Random Jitter (RJ)	Note 11			1	ps <sub>RMS</sub>
	Deterministic Jitter (DJ)	Note 12			10	ps <sub>PP</sub>
	Clock Cycle-to-Cycle Jitter (RJ)	Note 13			1	ps <sub>RMS</sub>
	Total Jitter (TJ)	Note 14			10	ps <sub>PP</sub>
	Crosstalk-Induced Jitter Channel-to-Channel	Note 15, Within-bank.			0.7	ps <sub>RMS</sub>
t <sub>r</sub> , t <sub>f</sub>	Output Rise/Fall Time 20% to 80%	At full swing.	20	55	80	ps

#### Notes:

- High-speed AC parameters are guaranteed by design and characterization. V<sub>IN</sub> swing ž 100mV unless otherwise noted.
- 8. Input-to-input skew is the difference in time between two inputs to the output within a bank.
- 9. Bank-to-bank skew is the difference in time from input to the output between bank.
- 10. Part-to-part skew is defined for two parts with identical power supply voltages at the same temperature and with no skew of the edges at the respective inputs.
- 11. Random jitter is measured with a K28.7 comma detect character pattern, measured at 5Gbps and 2.5Gbps/3.2Gbps.
- 12. Deterministic jitter is measured at 2.5Gbps/3.2Gbps, with both K28.5 and 2<sup>23</sup>–1 PRBS pattern.
- 13. Cycle-to-cycle jitter definition: the variation of periods between adjacent cycles,  $T_n T_{n-1}$  where T is the time between rising edges of the output signal.
- 14. Total jitter definition: with an ideal clock input of frequency f<sub>MAX</sub>, no more than one output edge in 10<sup>12</sup> output edges will deviate by more than the specified peak-to-peak jitter value.
- 15. Crosstalk is measured at the output while applying two similar frequencies that are asynchronous with respect to each other at the inputs.

#### TRUTH TABLES

INA0	/INA0	INA1	/INA1	SELA	QA	/QA
0	1	Х	X	0	0	1
1	0	Х	Х	0	1	0
Х	Х	0	1	1	0	1
X	Х	1	0	1	1	0

INB0	/INB0	INB1	/INB1	SELB	QB	/QB
0	1	Х	Х	0	0	1
1	0	Х	Х	0	1	0
Х	Х	0	1	1	0	1
X	Х	1	0	1	1	0

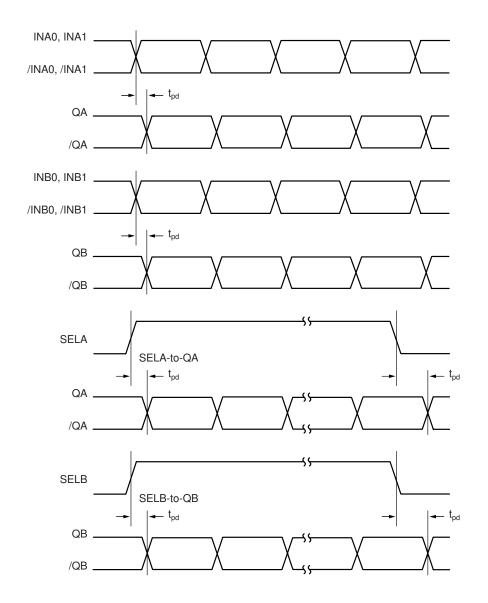
### SINGLE-ENDED AND DIFFERENTIAL SWINGS



Figure 1a. Single-Ended Voltage Swing

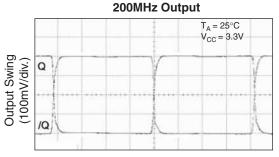
Figure 1b. Differential Voltage Swing

#### **TIMING DIAGRAM**

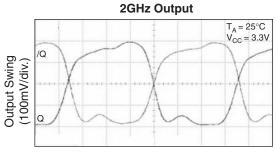


#### TYPICAL OPERATING CHARACTERISTICS

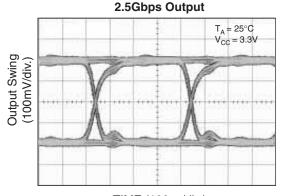
 $V_{CC}$  = 3.3V,  $T_A$  = 25°C,  $R_L$  = 50ý to  $V_{CC}$  – 2V, DC coupled, unless otherwise stated.



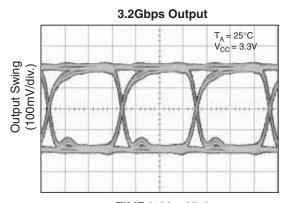
TIME (600ps/div.)



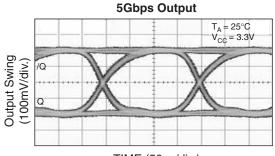
TIME (70ps/div.)



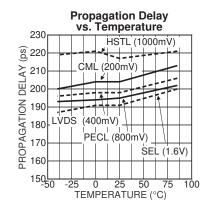
TIME (100ps/div.)

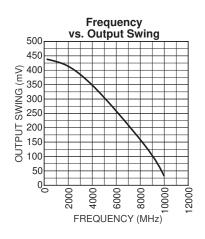


TIME (100ps/div.)

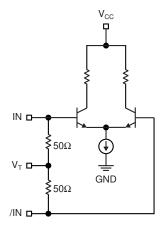


TIME (50ps/div.)





### INPUT AND OUTPUT STAGE INTERNAL TERMINATION



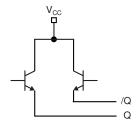


Figure 2a. Simplified Differential Input Stage

Figure 2b. Simplified LVPECL Output Stage

#### INPUT INTERFACE APPLICATIONS

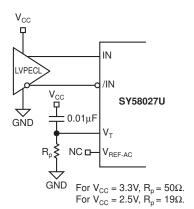


Figure 3a. DC-Coupled PECL Interface

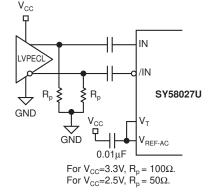


Figure 3b. AC-Coupled PECL Interface

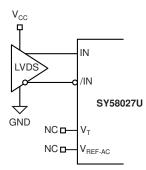
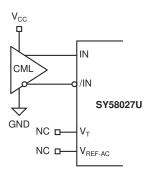


Figure 3c. LVDS Interface



Option: May connect  $V_T$  to  $V_{CC}$ .

Figure 3d. DC-Coupled CML Interface

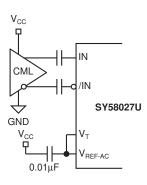


Figure 3e. AC-Coupled CML Interface

## **OUTPUT INTERFACE APPLICATIONS**

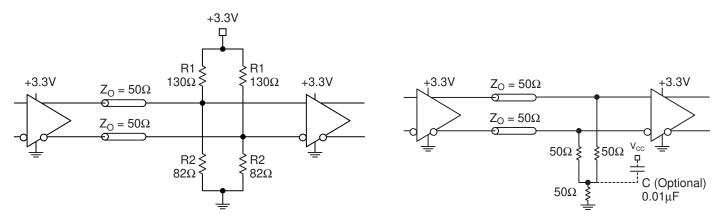


Figure 4a. Parallel Thevenin-Equivalent Termination

Figure 4b. Parallel Termination (3-Resistor)

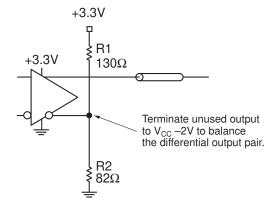
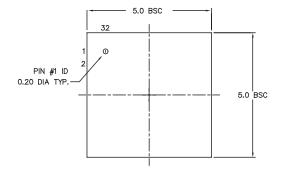


Figure 4c. Terminating Unused Output

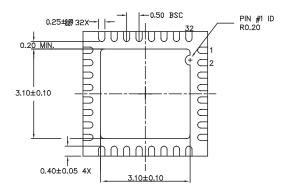
## RELATED MICREL PRODUCTS AND SUPPORT DOCUMENTATION

Part Number	Function	Data Sheet Link
SY58016L	3.3V 10Gbps Differential CML Line Driver/Receiver with Internal Termination	http://www.micrel.com/product-info/products/sy58016l.shtml
SY58017U	10.7Gbps Differential CML 2:1 MUX with Internal Termination	http://www.micrel.com/product-info/products/sy58017u.shtml
SY58018U	5Gbps LVPECL 2:1 MUX with Internal Termination	http://www.micrel.com/product-info/products/sy58018u.shtml
SY58019U	10.7Gbps 400mV LVPECL 2:1 MUX with Internal Termination	http://www.micrel.com/product-info/products/sy58019u.shtml
SY58025U	10.7Gbps Dual 2:1 CML MUX with Internal Termination	http://www.micrel.com/product-info/products/sy58025u.shtml
SY58026U	5Gbps Dual 2:1 LVPECL MUX with Internal Termination	http://www.micrel.com/product-info/products/sy58026u.shtml
SY58051U	10.7Gbps AnyGate <sup>®</sup> with Internal Input and Output Termination	http://www.micrel.com/product-info/products/sy58051u.shtml
SY58052U	10Gbps Clock/Data Retimer with 50ý Input Termination	http://www.micrel.com/product-info/products/sy58052u.shtml
	MLF™ Application Note	www.amkor.com/products/notes_papers/MLF_AppNote_0902.pdf
HBW Solutions	New Products and Applications	www.micrel.com/product-info/products/solutions.shtml

## 32-PIN *Micro*LeadFrame<sup>®</sup> (MLF-32)



TOP VIEW



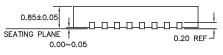
TOM VIEW

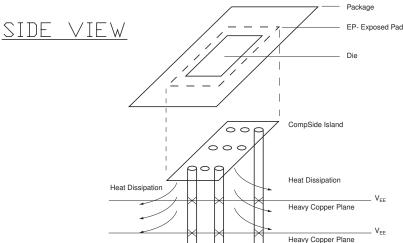
#### NOTE

- ALL DIMENSIONS ARE IN MILLIMETERS.
- MAX. PACKAGE WARPAGE IS 0.05 mm.

  MAXIMUM ALLOWABE BURRS IS 0.076 mm IN ALL DIRECTIONS.

  PIN #1 ID ON TOP WILL BE LASER/INK MARKED.





PCB Thermal Consideration for 32-Pin MLF® Package (Always solder, or equivalent, the exposed pad to the PCB)

#### Package Notes:

- 1. Package meets Level 2 Moisture Sensitivity Classification.
- 2. All parts are dry-packaged before shipment.
- 3. Exposed pads must be soldered to a ground for proper thermal management.

#### MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA

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